

PRM5R2N06CT

PFC Device Corporation

60V Single N-Channel MOSFET

Major ratings and characteristics

Characteristics	Values	Units
V_{DS}	60	٧
$I_D^6 (T_C=25^{\circ}C)$	110	Α
Max. R _{DS(ON)} @V _{GS} =10V	5.2	mΩ
Max. R _{DS(ON)} @V _{GS} =4.5V	7	mΩ
T _J Operating Junction Temperature	-55 to +150	°C

General Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.

PRM5R2N06CT TO-220AB

Typical Applications

- Charger Adapter
- Power Tools
- LED Lighting

Features

- Max. $R_{DS(ON)}=5.2m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- 100% E_{AS} Guaranteed
- Green Device Available

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1. Characteristics

Maximum Ratings Characteristics

($T_A = 25$ °C unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	±20	V
I _D ⁵	Drain Current – Continuous (T _C =25°C)	156	Α
'D	Drain Current – Continuous (T _C =100°C)	99	Α
I_D^6	Drain Current – Continuous (T _C =25°C)	110	Α
I _{DM}	Drain Current – Pulsed ¹	350	Α
E _{AS}	Single Pulse Avalanche Energy ²	80	mJ
I _{AS}	Single Pulse Avalanche Current ²	40	А
В	Power Dissipation (T _C =25°C)	204	W
P _D	Power Dissipation – Derate above 25°C	1.63	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient		62	°C/W
$R_{ heta JC}$	Thermal Resistance Junction to Case		0.61	°C/W



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Electrical Characteristics

(T_J = 25 °C unless otherwise specified)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	60			V
	Drain Course Leekees Current	V _{DS} =60V, V _{GS} =0V, T _J =25°C			1	uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =60V, V _{GS} =0V, T _J =125°C			250	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA

On Characteristics

D	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A		4.3	5.2	mΩ
$R_{DS(ON)}$		V _{GS} =4.5V, I _D =10A		6	7	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_{D}=250uA$	1.0	1.8	3.0	V
g_{fs}	Forward Transconductance	V _{DS} =5V, I _D =20A	-	65	I	S

Dynamic and switching Characteristics

Q_q	Total Gate Charge ^{3, 4}		 85	
Q_{qs}	Gate-Source Charge ^{3, 4}	V_{DS} =30V, V_{GS} =10V, I_{D} =20A	 15	 nC
Q_{gd}	Gate-Drain Charge ^{3, 4}		 20	
T _{d(on)}	Turn-On Delay Time ^{3, 4}		 19	
T _r	Turn-On Rise Time ^{3, 4}	V_{DD} =30V, V_{GS} =10V, R_{G} =6 Ω	 51	 ns
$T_{d(off)}$	Turn-Off Delay Time ^{3, 4}		 67	 115
T_f	Turn-Off Fall Time ^{3, 4}		 78	
C _{iss}	Input Capacitance		 4950	
C _{oss}	Output Capacitance	V _{DS} =25V, V _{GS} =0V, f=1MHz	 310	 pF
C _{rss}	Reverse Transfer Capacitance		 200	
R_{g}	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	 0.5	 Ω

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	V_{GS} =0V, I_{S} =20A			1.5	V
t _{rr}	Reverse Recovery Time	L _20A di/dt_100A/ug	-	20		ns
Q _{rr}	Reverse Recovery Charge	I _S =20A, di/dt=100A/us		7		nC

Note:

- 1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
- 2. L=0.1mH, $R_G=25\Omega$, Starting $T_J=25^{\circ}C$
- 3. The data tested by pulsed , pulse width ≤300us, duty cycle ≤2%.
- 4. Essentially independent of operating temperature.
- 5. Silicon limited.
- 6. Package limited.



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2. Characteristics Curves

Ratings and Characteristics Curves

(T_A = 25° unless otherwise specified)

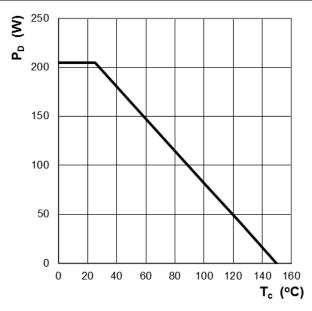


Figure 1: Power Dissipation

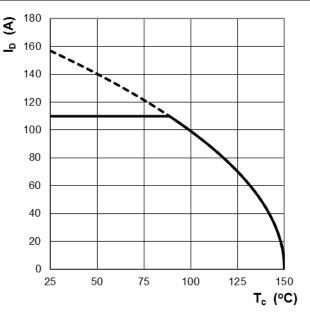


Figure 2: Continuous Drain Current vs. T_C

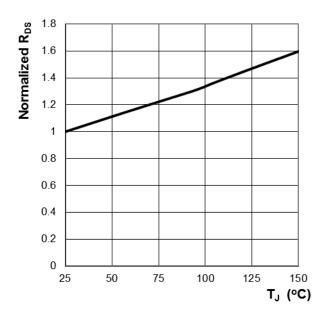


Figure 3: Normalized R_{DS(ON)} vs. T_J

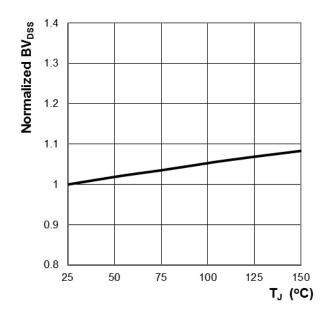


Figure 4: Normalized BV_{DSS} vs. T_J



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Ratings and Characteristics Curves

(T_A = 25° unless otherwise specified)

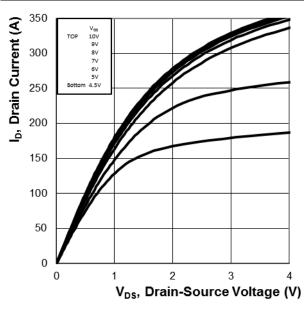


Figure 5: On-Region Characteristics

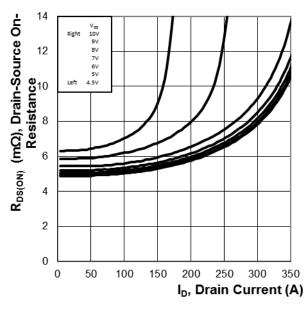


Figure 6: Typ. R_{DS} Variation vs. I_D and V_{GS}

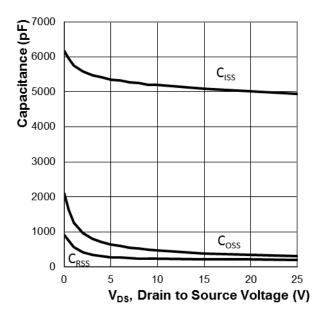


Figure 7: Typ. Capacitance Characteristics

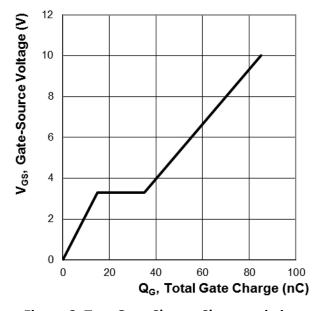


Figure 8: Typ. Gate Charge Characteristics



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Ratings and Characteristics Curves

(T_A = 25°C unless otherwise specified)

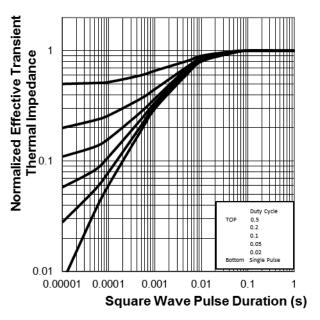


Figure 9: Normalized Thermal Transient Impedance, Junction-to-Case

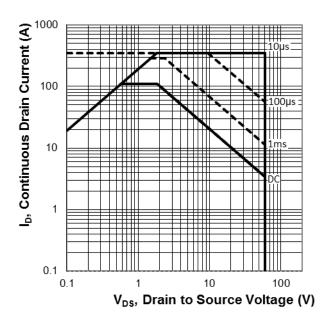


Figure 10: Maximum Safe Operation Area



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3. Marking information

Top Marking Rule

PFC PRM
5R2N06CT
YYWW ABSH

PRM5R2N06CT = Product Type Marking Code

YYWW = Date Code

YY = Last two digits of year

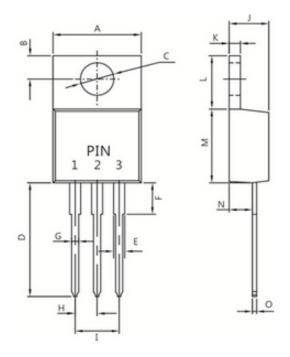
WW = Week code

ABS = Assembly code

H = Halogen Free (N/A = common molding compound)

4. Package information

Package Outline Dimensions millimeters



Dim.	Min.	Max.		
Α		10.50		
В	2.50	3.50		
С	3.50	4.10		
D	13.10	13.90		
Е	1.15	1.45		
F		6.35		
G	0.65	0.95		
Н	2.29	2.79		
1	4.80	5.30		
J	4.40	4.80		
K	1.14	1.40		
L	5.84	6.86		
М	8.50	9.60		
N	2.03	2.92		
0	0.30	0.64		
All Dimensions in millimeter				



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5. Ordering information

Part Number	Package	Delivery mode
PRM5R2N06CT	TO-220AB	50 pcs / Tube

Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0
 Device Weight: 0.07 ounces (1.96grams) - TO-220AB

Mounting Torque : Recommended 4~5 kg-cm

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